

STB80NF03L-04

N-channel 30 V, 0.0035 Ω, 80 A, I²PAK STripFET™ II Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)}	I _D
STB80NF03L-04	30V	< 0.004Ω	80A

- Exceptional dv/dt capability
- 100% avalanche tested
- Low threshold drive

Application

- Switching applications
 - Automotive



This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

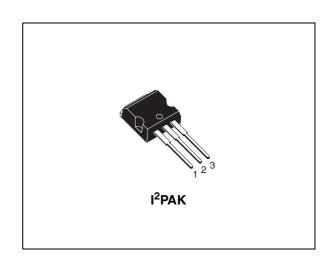


Figure 1. Internal schematic diagram

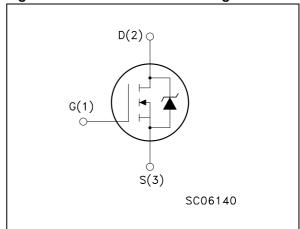


Table 1. Device summary

Order codes	des Marking Package		Packaging	
STB80NF03L-04	80NF03L-04	I ² PAK	Tube	

Contents STB80NF03L-04

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STB80NF03L-04 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate- source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C	80	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100°C	80	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	320	Α
P _{TOT}	Total dissipation at T _C = 25°C	300	W
	Derating factor	2	W/°C
dv/dt (3)	Peak diode recovery voltage slope	2	V/ns
E _{AS} ⁽⁴⁾	Single pulse avalanche energy	2.3	J
T _{stg} Tj	Storage temperature Operating junction temperature -60 to 175		°C

^{1.} Limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case Max	0.5	°C/W
Rthj-amb	Thermal resistance junction-ambient Max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

^{2.} Pulse width limited by safe operating area

^{3.} $I_{SD} \leq 80 A$, di/dt ≤ 240 A/ μ s, $V_{DD} \leq V_{(BR)DSS}$, $T_{J} \leq T_{JMAX}$

^{4.} Starting Tj = 25°C, I_D = 80 A, V_{DD} = 50 V

Electrical characteristics STB80NF03L-04

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250\mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating @125°C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10V, I_D = 40A$ $V_{GS} = 4.5V, I_D = 40A$		0.0035 0.004	0.004 0.0055	Ω Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V _, I _D = 15A	-	50	-	S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	Output capacitance $V_{DS} = 25V$, $f = 1$ MHz, $V_{GS} = 0$		5500 1670 290	-	pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 24V, I_{D} = 80A, V_{GS} = 4.5V (see Figure 15)	-	85 23 40	110	nC nC nC

^{1.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Table 6. Switching times

Symbo	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \end{array}$	Turn-on delay time Rise time Turn-off-delay time Fall time	V_{DD} = 15V, I_{D} = 40A, R_{G} = 4.7 Ω , V_{GS} =4.5V (see Figure 16)	-	30 270 110 95	-	ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		320	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 80A, V _{GS} = 0	-		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =80A, V_{DD} = 20V di/dt = 100A/ μ s, T_j =150°C	-	75 0.15 4		ns µC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STB80NF03L-04

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

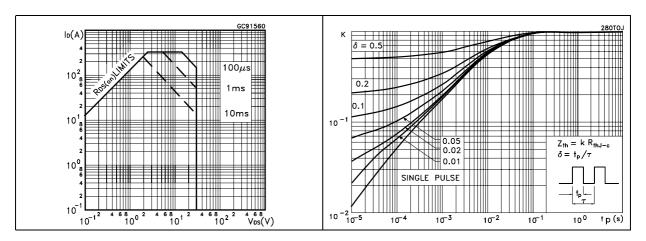


Figure 4. Output characteristics

Figure 5. Transfer characteristics

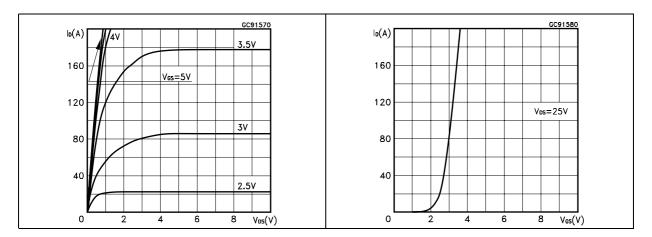


Figure 6. Transconductance

Figure 7. Static drain-source on-resistance

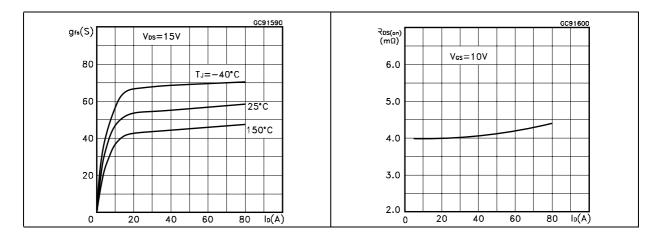


Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations

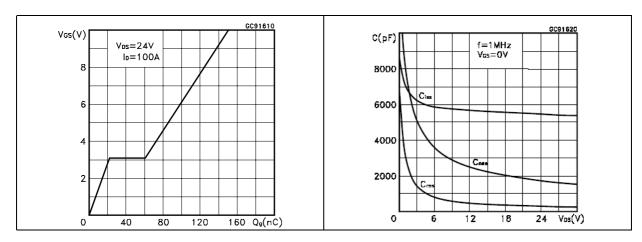


Figure 10. Normalized gate threshold voltage vs. temperature

Figure 11. Normalized on-resistance vs. temperature

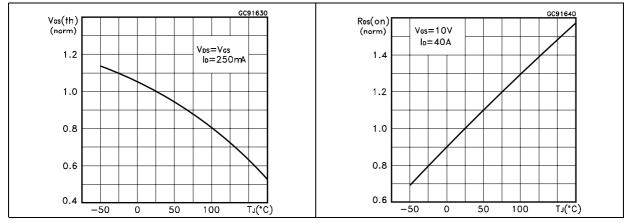
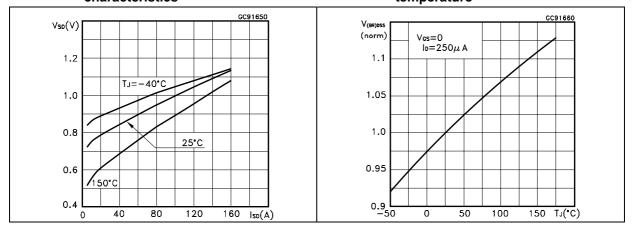


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized breakdown voltage vs temperature



Test circuits STB80NF03L-04

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

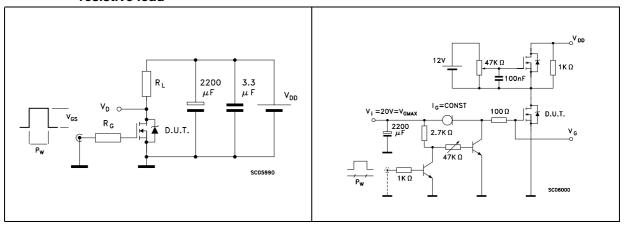


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

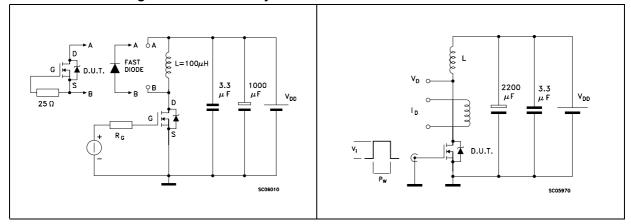
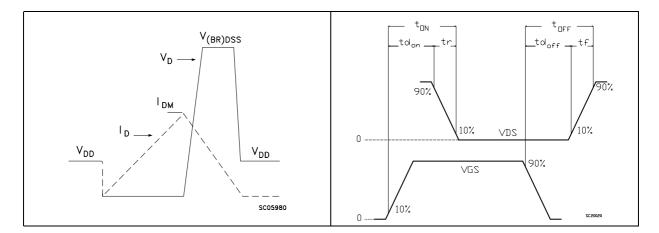


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform

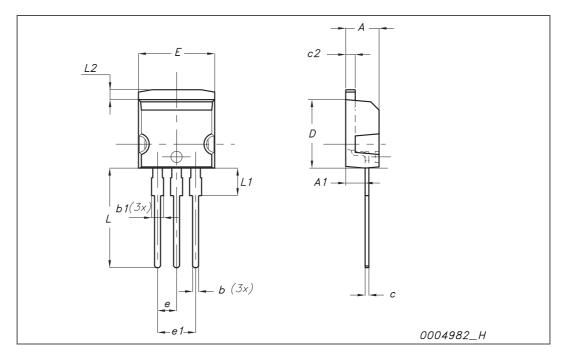


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

I²PAK (TO-262) mechanical data

Dim	mm				inch	
Dilli	Min	Тур	Max	Min	Тур	Max
A	4.40		4.60	0.173		0.181
A1	2.40		2.72	0.094		0.107
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.49		0.70	0.019		0.027
c2	1.23		1.32	0.048		0.052
D	8.95		9.35	0.352		0.368
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
E	10		10.40	0.393		0.410
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L2	1.27		1.40	0.050		0.055



STB80NF03L-04 Revision history

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
01-Oct-2009	1	Initial release

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